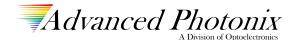


PDB-C156

Silicon Photodiode

The PDB-C156 is an 8 mm² active area BLUE enhanced PIN silicon photodiode assembled in water clear side looking plastic molded package.

Applications	Features		
Smoke Detectors	Plastic Mold Package		
Data Link	Photoconductive		
NIR Remotes	High Speed		





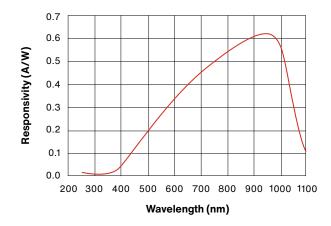
Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit				
Reverse Voltage	$V_{_{\mathrm{R}}}$	-	50	V				
Operating Temperature	T _{OP}	-40	+80	°C				
Storage Temperature	T _{STG}	-40	+100	°C				
Package	Sidelooking Plastic Mold							

Typical Electro-Optical Specifications at T_A=23 °C

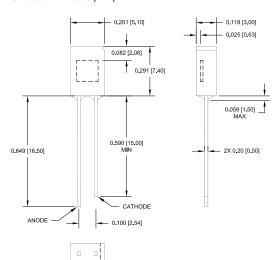
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Active Area	-	A.A.	-	8.02	-	mm²
Spectral Range	-	λ	400	-	1100	nm
Short Circuit Current	H=100 fc, 2850K	I _{sc}	70	90	-	μΑ
Capacitance	V _R =10V;f=1MHz	C _J	-	10	15	pF
Dark Current	V _R =10V	I _D	-	2	15	nA
Shunt Resistance	V _R =10mV	R_{\scriptscriptstyleSH}	100	150	-	МΩ
Noise Equivalent Power	V_R =10V @ λ =Peak	NEP	-	4.4x10 ⁻¹⁴	-	W/ √ Hz
Response Time	$R_L=1K\Omega, V_R=10V$	T _R	-	15	-	nS

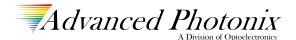
Spectral Response



Mechanical Specifications

Units are in inches (mm)







Care and handling instructions

Your optoelectronic components are packaged and shipped in opaque, padded containers to avoid ambient light exposure and damage due to shock from dropping or jarring.

Care must be taken to avoid exposure to high ambient light levels, particularly from tungsten sources or sunlight.

- These components can be rendered inoperable
 if dropped or sharply jarred. The wire bonds are
 delicate and can become separated from the
 bonding pads when the component is dropped or
 otherwise receives a sharp physical blow.
- Most windows on photodiodes are either silicon or quartz. They should be cleaned with isopropyl alcohol and a soft (optical grade) pad.
- Photodiode exposure to extreme high or low storage temperatures can affect the subsequent performance. Maintain a non-condensing environment for optimum performance and lifetime.
- All devices are considered ESD sensitive.
 The photodiodes are shipped in ESD protective packaging. When unpacking and using these products, anti-ESD precautions should be observed.
- Photodiode packages and/or operation may be impaired if exposed to CHLOROETHENE, THINNER, ACETONE, TRICHLOROETHYLENE or any harsh chemicals.
- **Legal Disclaimer**

Information in this data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice.



Most of our standard catalog products are RoHS Compliant. Please contact us for details.

- Optoelectronic components in plastic packages should be given special care. Clear plastic packages are more sensitive to environmental stress than those of black plastic. Storing devices in high humidity can present problems when soldering. Since the rapid heating during soldering stresses the wire bonds and can cause wire to bonding pad separation, it is recommended that devices in plastic packages to be baked for 24 hours at 85°C.
- The leads on the photodiode SHOULD NOT BE FORMED. If your application requires lead spacing modification, please contact Advanced Photonix Applications group at Techsupport@advancedphotonix.com before forming a product's leads. Product warranties could be voided.
- Most devices are provided with wire or pin leads for installation in circuit boards or sockets. Observe the soldering temperatures and conditions specified below:
 - Soldering Iron: Soldering 30 W or less
 - Temperature at tip of iron 300°C or lower.
 - Dip Soldering: Bath Temperature: 260±5°C.
 - Immersion Time: within 5 Sec.
 - Soldering Time: within 3 Sec.
 - Vapor Phase Soldering, Reflow Soldering: DO NOT USE



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